

STGW40NC60W

40 A - 600 V - ultra fast IGBT

Features

- Low C_{RES} / C_{IES} ratio (no cross conduction susceptibility)
- High frequency operation

Applications

- High frequency inverters, UPS
- Motor drivers
- HF, SMPS and PFC in both hard switch and resonant topologies
- Welding
- Induction heating

Description

This IGBT utilizes the advanced PowerMESF'TM process resulting in an excellent trad:--vff between switching performance or d low on-state behavior.

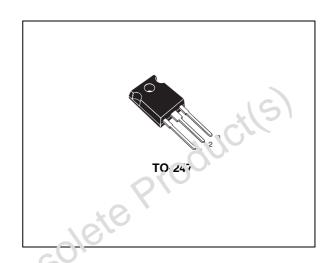


Figure 1. Internal schematic diagram

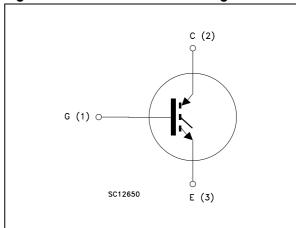


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW40NC60W	GW40NC60W	TO-247	Tube

Contents STGW40NC60W

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Obs	Electrical characteristics

STGW40NC60W **Electrical ratings**

Electrical ratings 1

Table 2. **Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Collector current (continuous) at 25 °C	70	Α
I _C ⁽¹⁾	Collector current (continuous) at 100 °C	40	Α
I _{CL} (2)	Turn-off latching current	230	Α
I _{CP} (3)	Pulsed collector current	230	А
V _{GE}	Gate-emitter voltage	±20	V
P _{TOT}	Total dissipation at T _C = 25 °C	250	W
T _j	Operating junction temperature	- 55 to 150	°C
. Calculate	d according to the iterative formula:		
$I_{C}(T_{C}) = \frac{1}{R_{THJ}}$		i e	
. Vclamp =	80%(V _{CES}), Ti = 150 °C, R _G = 10 Ω, V _{GES} 15 '		

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T}C, ^{I}C)}$$

- 2. Vclamp = 80%(V_{CES}), Tj = 150 °C, R_G = 10 Ω , V_{GE}= 15 $^{\prime\prime}$
- 3. Pulse width limited by max. junction temperature allowed

Thermal resistance Table 3.

	Symbol	Parameter	Value	Unit
	R _{thj-case}	Thermal resistance junction-case max	0.5	°C/W
	R _{thj-amb}	Tremal resistance junction-ambient max	50	°C/W
Obsole	ie P			

Electrical characteristics STGW40NC60W

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(T_{CASE} =25 °C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			٧
V _{CE(sat)}	Collector-emitter saturation voltage	V_{GE} = 15 V, I_{C} = 30 A V_{GE} = 15 V, I_{C} = 30 A, T_{C} =125 °C		2.1 1.9	2.5	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_{C} = 250\mu A$	3.75	_^	5.75	٧
I _{CES}	Collector-emitter cut-off current (V _{GE} = 0)	V _{GE} = 600 V V _{GE} = 600 V, T _C =125 °C	70	70	500 5	μA mA
I _{GES}	Gate-emitter cut-off current (V _{CE} = 0)	V _{GE} = ± 20 V			±100	nA
9 _{fs}	Forward transconductance	V _{CE} = 15 V, I _C = 30 A		20		S
		100				
Table 5.	Dynamic					
Symbol	Parameter	Tost conditions	Min	Tvn	Max	Hnit

Table 5. **Dynamic**

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacital ce	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0		2900 298 59		pF pF pF
Q _g Q _{ge} Q _{Jc}	ictal gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390 V, I_{C} = 30 A, V_{GE} = 15 V (see Figure 17)		126 16 46		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390 V, I_{C} = 30 A R_{G} = 10 Ω , V_{GE} = 15 V (see Figure 16)		33 12 2600		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_{C} = 30 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{C} = 125 ^{\circ}\text{C}$ (see Figure 16)		32 14 2300		ns ns A/µs
$t_{r}(V_{off})$ $t_{d}(_{off})$ t_{f}	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390 V, I_{C} = 30 A, R_{GE} = 10 Ω , V_{GE} =15 V (see Figure 16)		26 168 06	ile	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_{C} = 30 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V}$ $T_{C} = 125 \text{ °C} (see Figure 16)$	O	54 213 67		ns ns ns

Table 7. Switching energy (inductive load)

	c interming circing, (interest					
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390 V, I_{C} = 30 A R_{G} = 10 Ω , V_{GE} = 15 V (see Figure 16)		302 349 651		µJ µJ µJ
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _t	Turn-ch switching losses Turn-off, switching losses Total switching losses	$V_{CC} = 390 \text{ V}, I_{C} = 30 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{C} = 125 \text{ °C}$ (see Figure 16)		553 750 1303		րJ րJ րJ

er n is the turn-on losses when a typical diode is used in the test circuit in figure 2 Eon include diode recovery energy. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & diode are at the same temperature (25 °C and 125 °C)

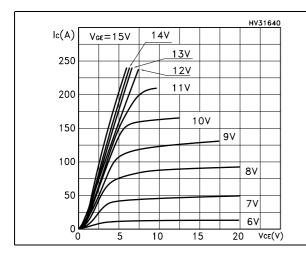
^{2.} Turn-off losses include also the tail of the collector current

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2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



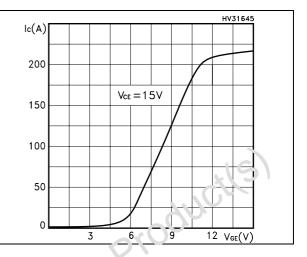
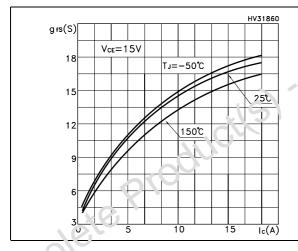


Figure 4. Transconductance

Figure 5. Collector emitter on voltage vs ten ve ature



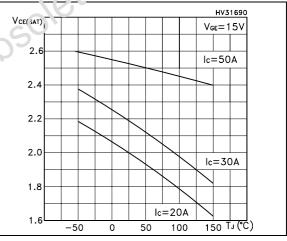
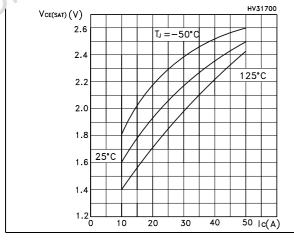
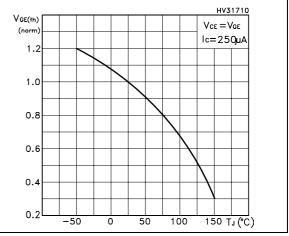


Figure 5. Collector-emitter on voltage vs collector current

Figure 7. Normalized gate threshold vs temperature





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Figure 8. Normalized breakdown voltage vs Figure 9. Gate charge vs gate-emitter voltage temperature

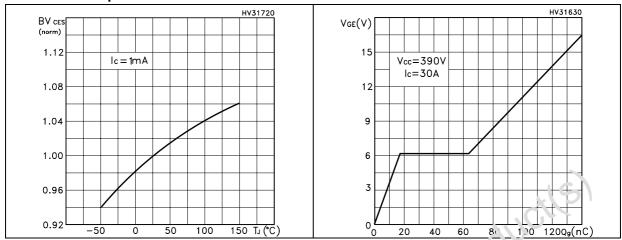


Figure 10. Capacitance variations

Figure 11. Switching losses vs temperature

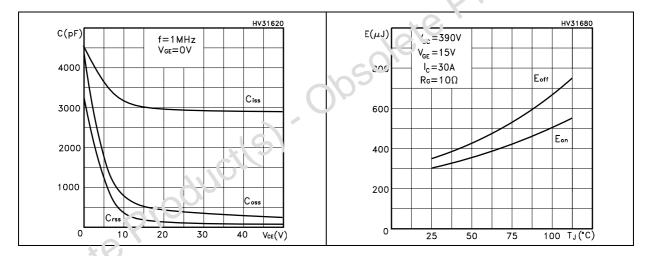
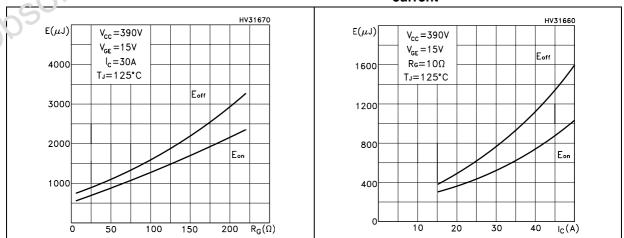


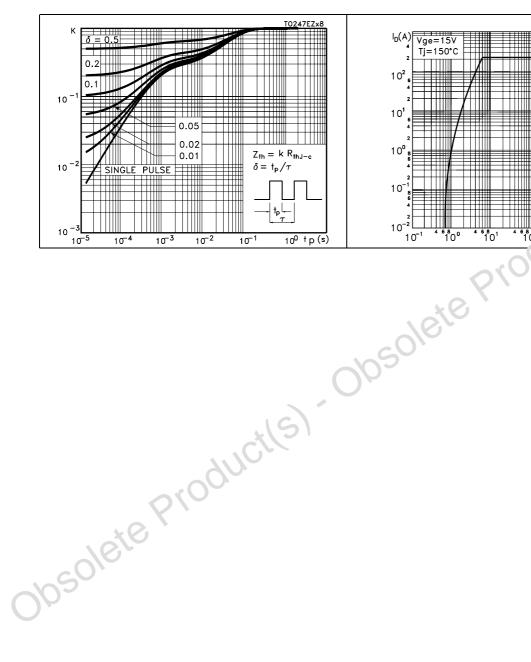
Figure 12: Switching losses vs gate resistance Figure 13. Switching losses vs collector current

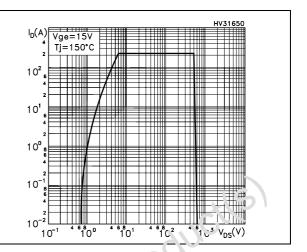


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Figure 14. Thermal impedance

Figure 15. Turn-off SOA





STGW40NC60W **Test circuit**

Test circuit 3

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

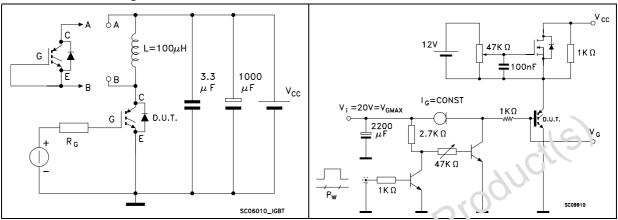
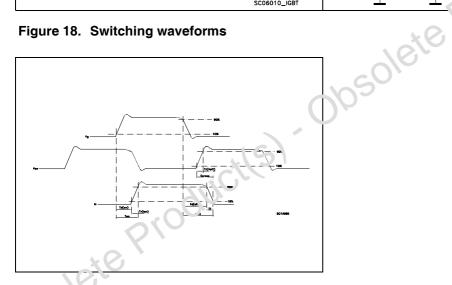


Figure 18. Switching waveforms



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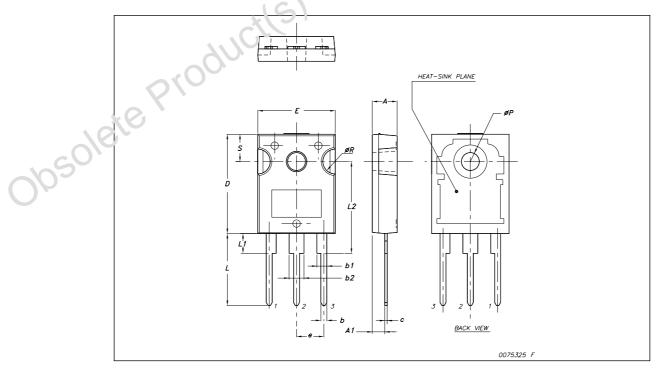
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s). Obsolete Product(s)

TO-247 Mechanical data

Dim.	mm.				
Dilli.	Min.	Тур	Max.		
Α	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		030		
D	19.85		?∂.15		
Е	15.45		15.75		
е		5.45			
L	14.20	1.0.	14.80		
L1	3.70	10,10	4.30		
L2		18.50			
øΡ	3.55	105	3.65		
øR	4.50		5.50		
S		5.50			



Revision history STGW40NC60W

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
09-Jul-2008	1	First release



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